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Dated: September 24, 2009

Electronic Signature for James E. Armstrong, IV: /James E. Armstrong, IV/

Docket No.: 80444(302768)
(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:
Etsuo Okahara et al.

Application No.: 10/535,423

Confirmation No.: 6153

Filed: May 19, 2005

Art Unit: 1791

For: IN-MOLD COAT-FORMING METHOD AND
IN-MOLD-COATED MOLD PRODUCT

Examiner: E. H. Lee

AMENDMENT IN RESPONSE TO NON-FINAL OFFICE ACTION

MS Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir/Madam:

INTRODUCTORY COMMENTS

In response to the Office Action dated June 24, 2009, please amend the above-identified U.S. patent application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks begin on page 6 of this paper.